

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	die with substrate and sescond adj substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 11:43
L2	1691	die with substrate and second adj substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 11:43
L3	809	die with substrate and second adj substrate and power	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 11:43

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L1	2669	(257/678).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 10:13
L2	3256	(recess or cavity) with substrate and die	USPAT	OR	OFF	2005/11/11 10:14
L3	6126	(recess or cavity) with substrate and die	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 10:14
L4	157	l1 and l3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 10:16
L5	619	(daughterboard or (daughter adj board)) same power	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 10:16